



Integrated Device Technology, Inc.
2975 Stender Way, Santa Clara, CA - 95054

PRODUCT/PROCESS CHANGE NOTICE (PCN)

PCN #: **L-0410-06** DATE: 11/5/2004
 Product Affected: IDTCSPU877, IDTCSPU877A
 IDT74SSTU32864, IDT74SSTU32864A
 IDT74SSTU32864C, IDT74SSTU32864D
 Date Effective: November 5, 2004

MEANS OF DISTINGUISHING CHANGED DEVICES:
 Product Mark
 Back Mark
 Date Code Date Code 0437 and later
 Other

Contact: Bimla Paul
 Title: Quality Assurance Manager Attachment: Yes No
 Phone #: (408)-654-6419
 Fax #: (408)-492-8362 Samples: Available upon request.
 E-mail: bimla.paul@idt.com

DESCRIPTION AND PURPOSE OF CHANGE:

- Die Technology
- Wafer Fabrication Process Maximum frequency is improved from 270 MHz to 340 MHz. This is a data sheet change only. There is no change in die technology, process or design.
- Assembly Process
- Equipment
- Material IDTCSPU877, IDTCSPU877A
- Testing IDT74SSTU32864, IDT74SSTU32864A
- Manufacturing Site IDT74SSTU32864C, IDT74SSTU32864D
- Data Sheet
- Other

RELIABILITY/QUALIFICATION SUMMARY:

There is no change in quality and reliability of the affected parts.

CUSTOMER ACKNOWLEDGMENT OF RECEIPT:

IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable.

IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.

Customer: _____ ***Approval for shipments prior to effective date.***
 Name/Date: _____ E-Mail Address: _____
 Title: _____ Phone# /Fax# : _____

CUSTOMER COMMENTS: _____

IDT ACKNOWLEDGMENT OF RECEIPT:

RECD. BY: _____ DATE: _____